

Product Summary

V_{RRM} (V)	I_o (A)	V_F (MAX) (V) @ +25°C	I_R (MAX) (μ A) @ +25°C
100	2	0.79	10

Description and Applications

The B2100AF is a 2A 100V single rectifier packaged in the low profile SMAF package. Providing low V_F and excellent reverse leakage stability at high temperatures, this device is ideal for use in general rectification applications such as:

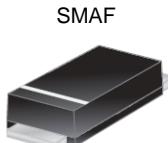
- Boost Diode
- Blocking Diode
- Recirculating Diode

Features and Benefits

- Reduced low forward voltage drop (V_F); Better efficiency and cooler operation.
- Reduced high-temperature reverse leakage; Increased reliability against thermal runaway failure in high temperature operation.
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

Mechanical Data

- Case: SMAF
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 ⑥③
- Polarity: Cathode Band
- Weight: 0.036 grams (Approximate)



Top View

Ordering Information (Note 4)

Part Number	Case	Packaging
B2100AF-13	SMAF	10,000/Tape & Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information

SMAF



B2100AF = Product Type Marking Code
 YWW = Date Code Marking
 Y = Last Digit of Year (ex: 5 for 2015)
 WW = Week Code (01 to 53)

Maximum Ratings (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V_{RRM}		
Working Peak Reverse Voltage	V_{RWM}	100	V
DC Blocking Voltage	V_{RM}		
Average Rectified Output Current	I_O	2	A
Non-Repetitive Peak Forward Surge Current 8.3ms	I_{FSM}	75	A
Single Half Sine-Wave Superimposed on Rated Load			

Thermal Characteristics

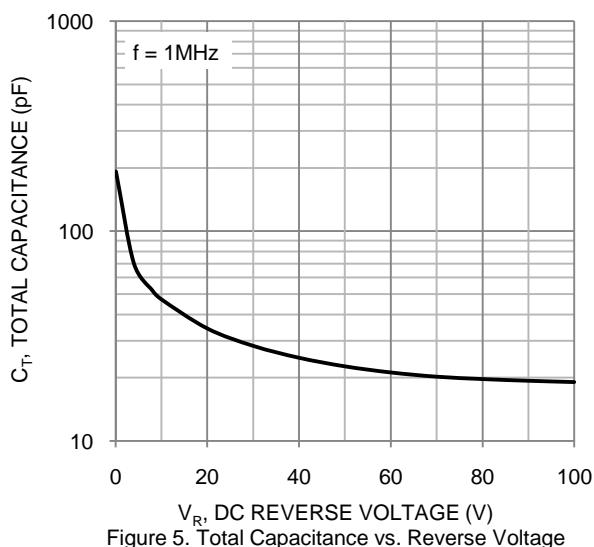
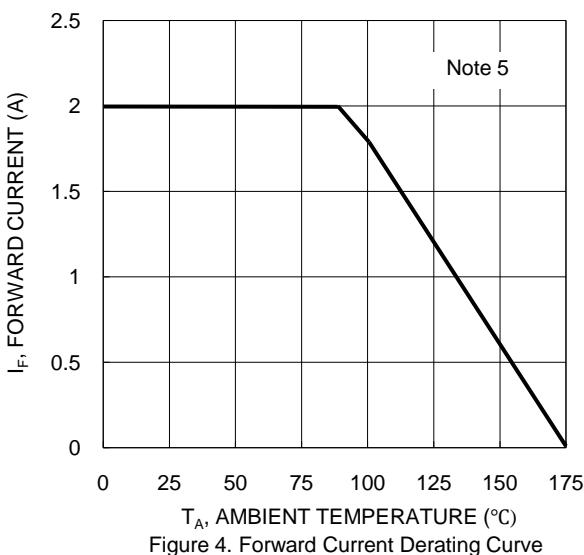
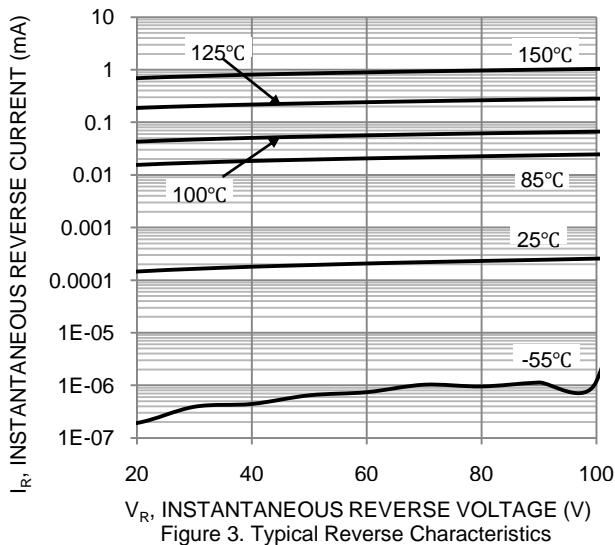
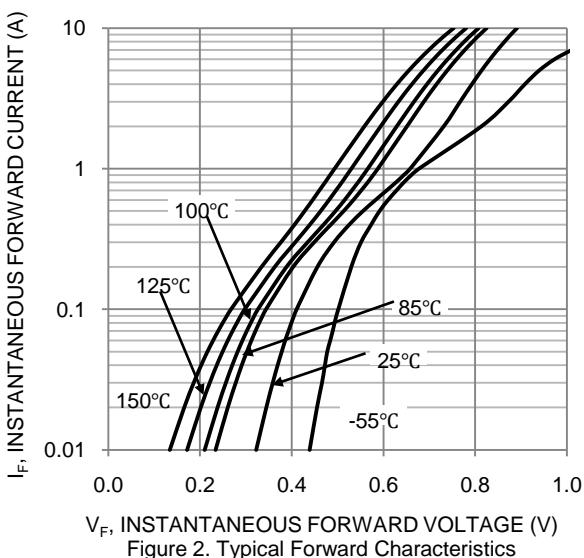
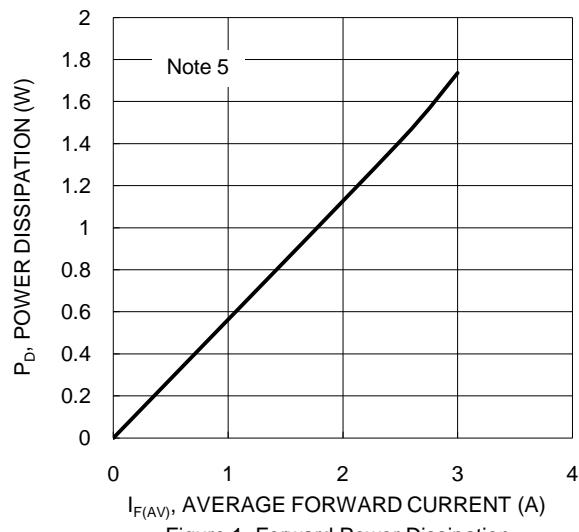
Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Ambient (Note 5)	$R_{\theta JA}$	90	$^\circ\text{C}/\text{W}$
Typical Thermal Resistance Junction to Case (Note 5)	$R_{\theta JC}$	23	$^\circ\text{C}/\text{W}$
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150	$^\circ\text{C}$

Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop	V_F	— —	0.75 0.60	0.79 0.65	V	$I_F = 2\text{A}, T_J = +25^\circ\text{C}$ $I_F = 2\text{A}, T_J = +125^\circ\text{C}$
Leakage Current (Note 6)	I_R	— —	— —	10 2	μA mA	$V_R = 100\text{V}, T_J = +25^\circ\text{C}$ $V_R = 100\text{V}, T_J = +125^\circ\text{C}$

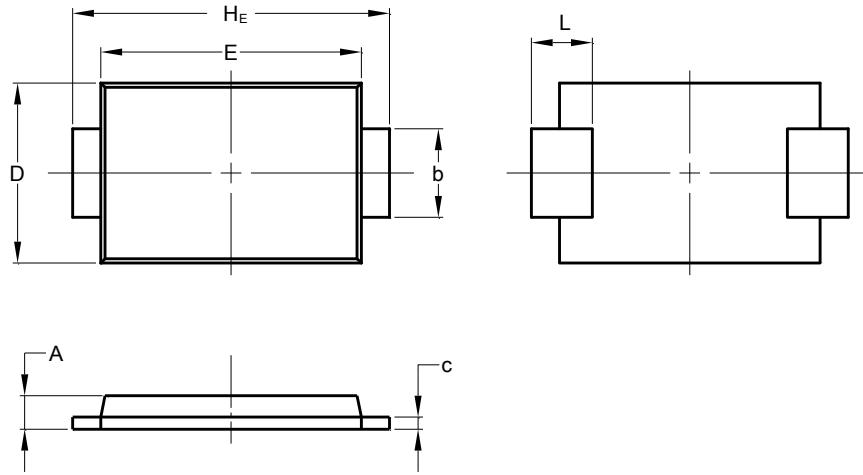
Notes: 5. Device mounted on FR-4 substrate, 0.4" x 0.5", 2oz, single-sided, PC boards with 0.2" x 0.25" copper pad.

6. Short duration pulse test used to minimize self-heating effect.



Package Outline Dimensions

Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.

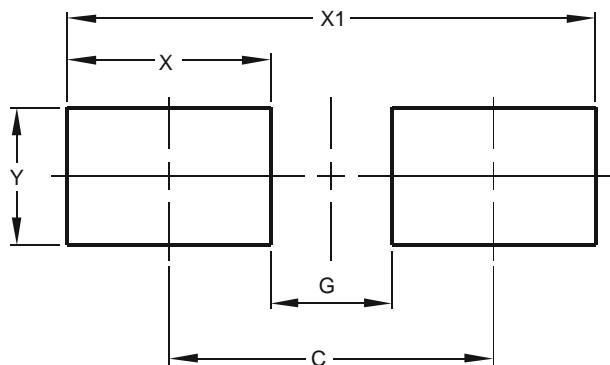


SMAF		
Dim	Min	Max
A	0.90	1.10
b	1.25	1.65
c	0.10	0.40
D	2.25	2.95
E	3.95	4.60
H_E	4.80	5.60
L	0.50	1.50

All Dimensions in mm

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
C	4.00
G	1.50
X	2.50
X1	6.50
Y	1.70

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